

Electronic Patent Application Fee Transmittal

Application Number:	10619591			
Filing Date:	16-Jul-2003			
Title of Invention:	Compositive laminate substrate with inorganic substrate and organic substrate			
First Named Inventor/Applicant Name:	Shih-Hsien Wu			
Filer:	Joe McKinney Muncy/Christian ream			
Attorney Docket Number:	3313-1016P			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				500